SK 50 GD 126 T



SEMITOP[®]4

3-phase bridge inverter

SK 50 GD 126 T

Target Data

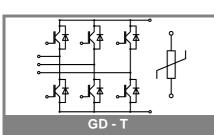
Features

- One screw mounting module
- Fully compatible with SEMITOP[®]1,2,3
- Improved thermal performances by aluminium oxide substrate
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

Typical Applications

- Inverter up to 28 kVA
- Typ. motor power 15 kW

1) $V_{CE,sat}$, V_F = chip level value

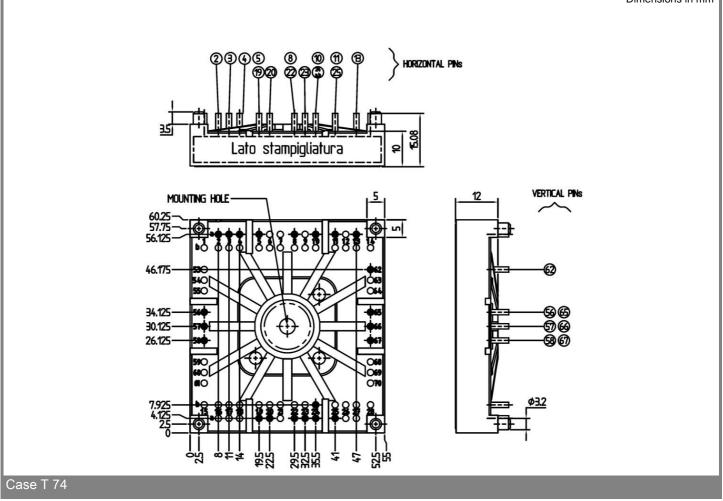


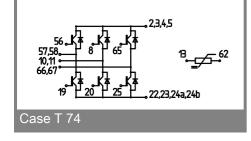
Absolute Maximum Ratings		Ts = 25 °C, unless otherwis	Ts = 25 °C, unless otherwise specified					
Symbol	Conditions	Values	Units					
IGBT - Inverter								
V _{CES}		1200	V					
I _C	T _s = 25 (70) °C	68 (52)	А					
I _{CRM}	, t _p = 1 ms	136	A					
V _{GES}		± 20	V					
Т _ј		-40 +150	°C					
Diode - II	nverter							
I _F	T _s = 25 (70) °C	62 (46)	A					
I _{FRM}	$I_{FRM} = 2xI_{Fnom}, t_p = 1 \text{ ms}$	124	A					
Т _ј		-40 +150	°C					
Rectifier	•	· · · ·	·					
V _{RRM}			V					
I _F	T _s = °C		A					
I _{FSM} / I _{TSM}	t _p = ms , sin ° ,T _i = °C		А					
l ² t	t _p = ms , sin ° ,T _i = °C		A²s					
T _i			°C					
T _{sol}	Terminals, 10 s	260	°C					
T _{stg}		-40 +125	°C					
V _{isol}	AC, 1 min. / 1 s	2500 / 3000	V					

Characteristics		Ts = 25 °C	Ts = 25 $^{\circ}$ C, unless otherwise specified				
Symbol	Conditions	min.	typ.	max.	Units		
IGBT - In	verter						
V _{CEsat} V _{GE(th)} V _{CE(TO)}	$I_{C} = 50 \text{ A}, T_{j} = 25 (125) ^{\circ}\text{C}$ $V_{GE} = V_{CE}, I_{C} = 2 \text{ mA}$ $T_{j} = 25 ^{\circ}\text{C} (125) ^{\circ}\text{C}$ $T_{-} = 25 ^{\circ}\text{C} (125) ^{\circ}\text{C}$	5	1,7 (2) 5,8 1 (0,9)	2,15 (2,45) 6,5 1,2 (1,1)	V V V		
r_{T} C_{ies} C_{oes} C_{res} $R_{th(j-s)}$	$T_{j} = 25 \ ^{\circ}C (125) \ ^{\circ}C$ $V_{CE} = 25 \ V_{GE} = 0 \ V, f = 1 \ MHz$ $V_{CE} = 25 \ V_{GE} = 0 \ V, f = 1 \ MHz$ $V_{CE} = 25 \ V_{GE} = 0 \ V, f = 1 \ MHz$ per IGBT		14 (22) - - - 0,6	19 (27)	mΩ nF nF nF K/W		
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \\ E_{on} \\ E_{off} \end{array}$	under following conditions $V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$ $I_C = 50 \text{ A}, T_j = 125 \text{ °C}$ $R_{Gon} = R_{Goff} = 12 \Omega$ inductive load		- - - - 5,6 6,5				
Diode - Ir	verter				1		
$V_F = V_{EC}$ $V_{(TO)}$ r_T $R_{th(j-s)}$	$ I_{F} = 50 \text{ A}, T_{j} = 25 (125) ^{\circ}\text{C} $ $ T_{j} = 25 ^{\circ}\text{C} (125) ^{\circ}\text{C} $ $ T_{j} = 25 ^{\circ}\text{C} (125) ^{\circ}\text{C} $ $ per diode $ $ under following conditions $		1,35 (1,35 0,95 (0,85 8 (10) 1		V V mΩ K/W		
I _{RRM} Q _{rr} E _{rr}	$I_F = A, V_R = V$ $V_{GE} = 0 V, T_j = 125 °C$ $di_F/dt = -A/\mu s$		-				
Diode ree		Т			1		
V _F V _(TO) r _T R _{th(j-s)}	$I_{F} = A, T_{j} = 25 \ ^{\circ}C$ $T_{j} = ^{\circ}C$ $T_{j} = ^{\circ}C$ per diode				V V mΩ K/W		
	tur sensor	I			1		
R _{ts}	5 %, T _r = 25 (100) °C		5000(493)		Ω		
Mechanie		I			1		
w M _s	Mounting torque		60 3,5		g Nm		

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Dimensions in mm





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.